

Website: www.displaytech.com.hk

LCD Module Product Specification

Product: 402A Series (40 Characters x 2 Lines)

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1. REVISION RECORD

VERSION	CHANGES	DATE
2.0	IC changed, and spec format changed	16 February 2009
2.1	Soldering iron temperature on page 19 was changed to 310°C	15 April 2009

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2. GENERAL SPECIFICATION

Item	Contents
Display Format	40 Characters x 2 Lines
Character matrix (W×H)	5×8 Dots
Character size (W×H)	3.20mm x 5.55mm
Dot size (W×H)	0.60mm x 0.65mm
Dot pitch (W×H)	0.65mm x 0.70mm
View Area	154.5mm x 15.8mm
Module Size	182.0mm x 33.5mm x 11.0mm MAX (14.0mm MAX w/LED backlight)
LCD Type	TN / STN / FSTN
Polarizer Mode	Reflective / Transflective / Transmissive
View Angle	6 o'clock / 12 o'clock
Backlight	LED / EL
Backlight Driver Type	External Power
Backlight Color	Yellow Green
Controller & LCD Driver	ST7066U-0A-B & ST7065C
Driving Method	1/16 Duty, 1/5Bias

3. ABSOLUTE MAXIMUN RATINGS

(Ta=25°C VSS=0V)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Power Supply for Logic	VDD	-0.3		7.0	V
Power Supply for LCD	VDD - V0	-0.3		15.0	V
Input Voltage	V_{IN}	-0.3		VDD+0.3	V
Normal Operating Temperature	Тор	0		50	°C
Normal Storage Temperature	Tst	-10		60	°C
Wide operating / storage temperature (except FSTN)	TOP / TST	-30		80	°C
Wide operating / storage temperature (FSTN)	TOP / TST	-30		70	°C

4. ELECTRICAL CHARACTERISTICS

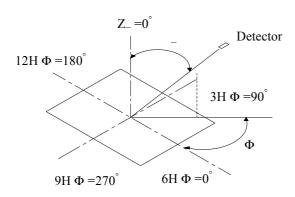
(Ta=25°C, VDD=5.0V±5%)

(1a 25 C, VBB 5.0 V							
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	
Power Supply for LCM	VDD		4.75	5.0	5.25	Volt	
I 1 XI - 14	$V_{ m IL}$	L level	Vss		0.2VDD	Volt	
Input Voltage	$V_{ m IH}$	H level	0.8VDD		Vdd	Volt	
LCD Dairean Dairein a							
LCD Driver Driving Voltage	V0-VSS	25°C		4.5		Volt	
Voltage							
Supply Current for	IDD	VDD=5.0V		4.5		A	
LCM	Ie *					mA	

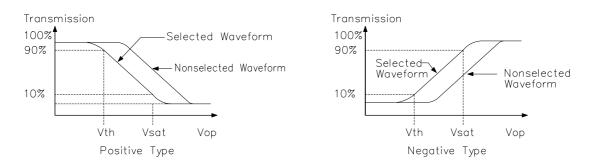
5. ELECTRO-OPTICAL CHARACTERISTICS

NO	Itom	Item Symbol Measuring STD.Value				Unit	Domonly			
NO	Item	Symbol	Condition	°C	Min	Тур	Max	Unit	Remark	
1	Recommended Operating Voltage	VLCD	$\Phi = 0$	25		5.0				
			_ = 0	0					Nata 1	
		Vth	$\Phi = 0$	25		1.30		V	Note1 Note2	
2	Operating		Ψ- 0	50					Note2	
2	Voltage		_=0	0						
		Vsat	Vsat	$\Phi = 0$	25		1.45			
			Ψ= 0	50						
		Tr	= 0	_=0	0					
			Ф= 10	25		97				
3	Response time			50				ms	Note4	
	Response time	Tf	Tf	_=0	0				1113	110164
				$\Phi = 10$	25		56			
			Ψ- 10	50						
		=-	$\Phi=0$ °	25		40				
4	Viewing	_	Ф=180°	25		30		Dog	Note1	
4	Angle (Cr 2)	_	Ф=90°	25		25		Deg	Note1	
		_	Ф=270°	25		25				
5	Current Consumption	ILCD	Hz=64	25		10.4		uA	Note3	

NOTE 1: DEFINITION OF VIEWING ANGLE AND DIRECTION



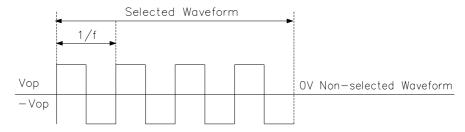
NOTE 2: THERSHOLD VOLTAGE AND SATURATION VOLTAGE



Vth: The voltage Vop which the transmission rate of segment is 90%(positive) or 10%(negative) of saturated value on conditions of the selected waveform.(non-selected waveform is opposition)

Vsat: The voltage Vop which the transmission rate of segment is 10%(positive) or 10%(negative) of saturated value on conditions of the selected waveform.(non-selected waveform is opposition)

NOTE 3: CURRENT CONSUMPTION (I LCD)

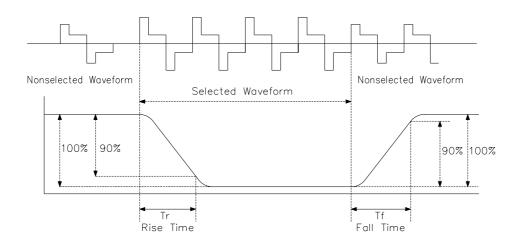


Conditions:

1.Driving waveform: static waveform.

2. Voltage applied to all segments

NOTE 4: RESPONSE TIME (Tr, Tf)



NOTE 5: CONTRAST RATIO (CR)

5.1 POSITIVE TYPE:

CONTRAST RATIO =

BRIGHTNESS AT VOP(NON-SELECTED)

BRIGHTNESS AT VOP(SELECTED)

5.2 NEGATIVE TYPE:

CONTRAST RATIO = BRIGHTNESS AT VOP(SELECTED)

BRIGHTNESS AT VOP(NON-SELECTED)

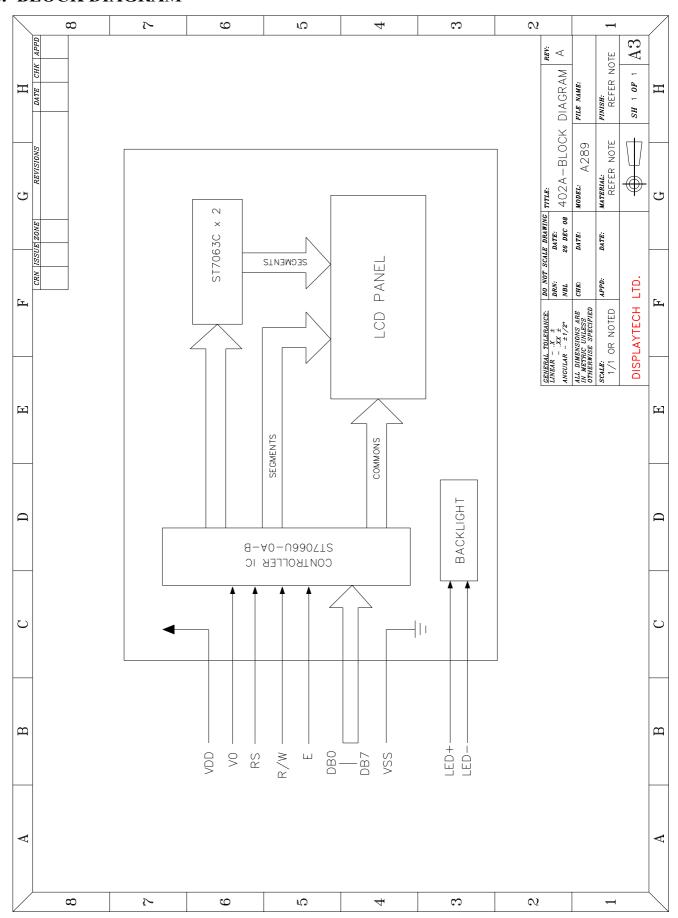
NOTE 6: CAPACITANCE (C)



Conditions:

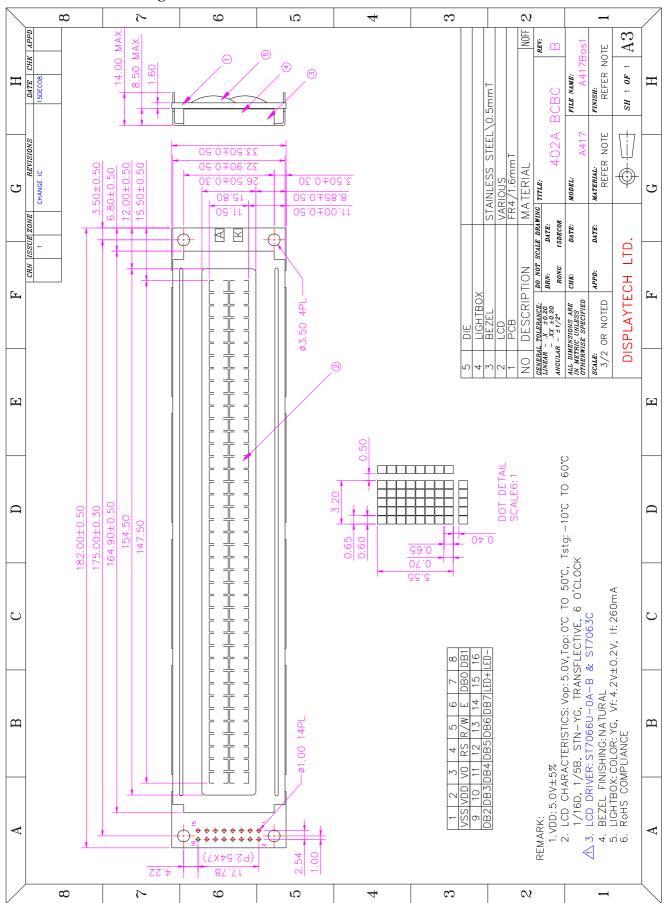
Voltage applied to all segments.

6. BLOCK DIAGRAM

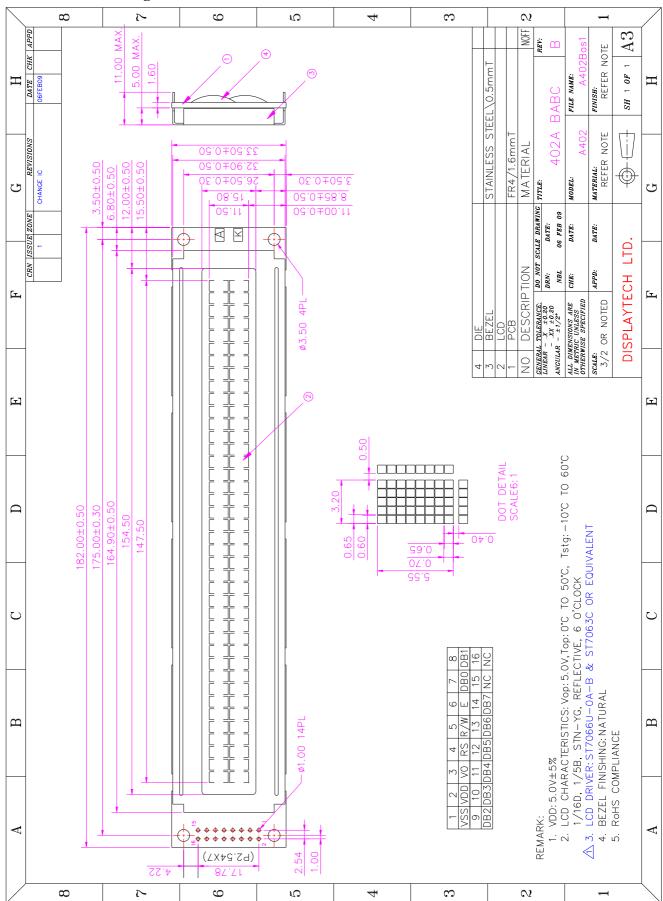


7. MECHANCIAL DRAWING

7.1. With LED Backlight

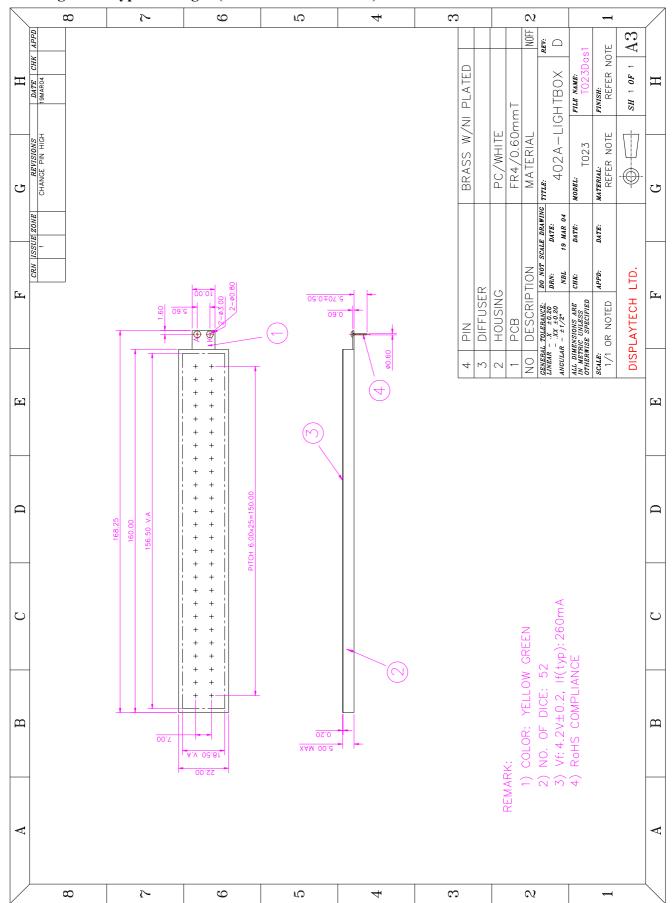


7.2. Without Backlight



8. BACKLIGHT DRAWING

8.1. Lightbox Type Backlight (Yellow Green in color)



9. BACKLIGHT SPECIFICATION

9.1. LIGHTBOX TYPE BACKLIGHT (YELLOW GREEN IN COLOR)

9.1.1. Mechanical Specifications

ITEM	NOMINAL DIMENSIONS	UNIT
OUTLINE SIZE (LxWxH)	168.25x22.0x5.0MAX	mm
VIEWING AREA (LxW)	156.5x18.5	mm
CONTACT PIN PITCH/LENGTH	P=5.6/L=5.7	mm
NO.OF LED SMT	52	

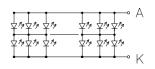
9.1.2. Electrical/Optical Characteristics (Ta=25°C, If=260mA typ.)

,		
MODE	PARAMETER	UNIT
COLOR	YELLOW GREEN	
WAVE LENGTH	573	nm
AVERAGE LUMINOUS INTENSITY (IV)	209 typ	cd/m ²
FORWARD VOLTAGE (Vf)	4.2 tvp	V

9.1.3. Absolute Maximum Rating

ITEM	VALUE	SYMBOL
FORWARD CURRENT	390mA	If
REVERSE VOLTAGE	5V	Vr
POWER DISSIPATION	1,638mW	Pd
OPERATING TEMPERATURE	-20°C TO 70°C	Тор
STORAGE TEMPERATURE	-30°C TO 80°C	Tstg

0	3	(5)		9	
2	<u> </u>	6	8		_ K



TESTING POINT

CIRCUIT DIAGRAM

REMARK:

- 1. AVERAGE LUMINOUS INTENSITY IS THE AVERAGE VALUE OF THE TEN INDICATED POINTS AS SHOWN.
- 2. MEASUREMENT INSTRUMENT: BM-7, APERTURE: '5mm.

10.QUALITY GUARANTEE

10.1. PURPOSE: It is to define the inspection standard of LCD modules

10.2. PRODUCT STANDARD

1) INSPECTION AND TEST

- FUNCTION TEST
- APPEARANCE INSPECTION
- PACKING SPECIFICTION

2) INSPECTION CONDITION

- Put under the lamp (20w×2) at a distance 100mm from the LCD Modules.
- Tilt upright 45 degree by the front (back) to inspect LCD appearance.

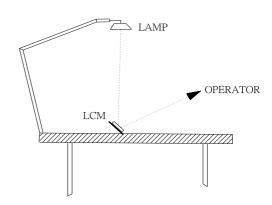
3) AQL INSPECTION LEVEL

• SAMPLING METHOD: MIL-STD-105D

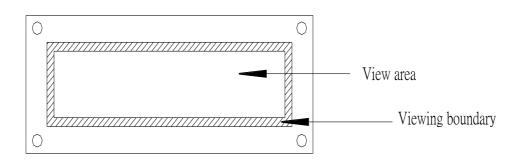
• SAMPLING PLAN : SINGLE

MAJOR DEFECT : 0.65% (MAJOR)
 MINOR DEFECT : 2.5% (MINOR)

• GENERAL LEVEL : II/NORMAL



10.3. DISPLAY AREA DEFINITION:



10.4. INSPECTION STANDARD

1) FUNCTIONAL TEST STANDARD

	1) FUNCTIONAL TEST STANDARD Inspection Standard Description Standard Defect type								
Item	I CD because 1	1	Inspection Standar	a Descri	ption			Standard Reject	
1		LCD has no display							MAJ
2	LCM display do not change						Reject	MAJ	
3	Display wrong	pattern	T					Reject	MAJ
4	Display segme	ent open	Missing segment	- \ II \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \					MAJ
5	Display dim se	Dim segment Dim segment						Reject	MAJ
6	Wrong LCD v	iewing dire	ction					Reject	MAJ
7	Dim Display	-						See sample	MAJ
8	LCD color var	iation						See sample	MAJ
	Pattern paralle	lism			A	cceptable rang	ge		
9	00000 00000 0	10000 00000 00000 0 3	20000 00000 00000 00000 00000 00000 00000	L ≥ 20: ≥ 30: ≥ 40: ≥ 50: ≥ 60: ≥ 70: ≥ 80: ≥ 90: ≥ 100:	mm mm mm mm mm	Ca 0.43° 0.38°	$\begin{array}{c} b \\ \leq 0.15 mm \\ \leq 0.2 mm \\ \leq 0.3 mm \\ \leq 0.35 mm \\ \leq 0.45 mm \\ \leq 0.50 mm \\ \leq 0.60 mm \\ \leq 0.65 mm \\ \leq 0.75 mm \end{array}$	Accept	
				•		Standa	rd		
			_ = = ×			$=\frac{x+y}{2}$	QTY		
						∂≤0.25	1	Accept	
10	LCD display					Ø>0.25	1	Accept	
10	Pin hole	×			Q	$0 < \frac{1}{4} W$	1	Accept	
			w_		Q	$0 > \frac{1}{4} W$	1	Reject	MIN

Item		Inspection Standar	d Descript	ion			Standard	Defect type
		Draw Standard					V 1	
		Ι. α		X	у	QTY		
				$\geq \frac{1}{4} b$	$\geq \frac{1}{4}a$	1	Reject	MIN
11	LCD display	×		(X or y)	≧0.2mm	1	Reject	MIN
11	Broken segment(dots)	+	<u>y</u>	$\leq \frac{1}{4} b$	$\leq \frac{1}{4}a$	1	Accept	
				$\leq \frac{1}{5}b$	$\leq \frac{1}{5}a$	2	Accept	
		× ×		$\emptyset = \frac{x+}{2}$	<u>y</u>	QTY		
	LCD display			Ø<0	.10		Accept	
12	Black spot or White spot		Ť	0.1<Ø	≦0.20	2	Accept	
			>	0.20≦€	0<0.25	1	Accept	
			\	$0.25 < \emptyset \le 0.4$		0	Reject	MIN
			L	Ø>().4	0	Reject	MAJ
			Black line	/white line(L×	w)mm	QTY		
			(L:	$(L \le 1.0) \times (W \le 0.025)$			Accept	
13	LCD display excess bl	ack line or white line	(1.0 <l< td=""><td>≦1.5)×(W≦-</td><td>· 0.025)</td><td>1</td><td>Accept</td><td></td></l<>	≦1.5)×(W≦-	· 0.025)	1	Accept	
			(L	>1.5)×(W \leq 0.	025)	0	Reject	MIN
					(L>2)×(W>0.025)			MAJ
14	Backlight not function							MAJ
15	LED not function or di						Reject	MIN
16	Backlight defect (dirt,	scratch)					Reject	MIN

2) COSMETIC INSPECTION STANDARD

Item	Standard description Standard	Standard	Defect type			
1	LCD inspection item					
1.1	LCD color variation	See sample	MIN			
1.2	LCD broken	Reject	MAJ			
1.3	Wrong polarizer of LCD	Reject	MAJ			
	Spot on LCD surface	Reject	MAJ			
	Scratch on LCD	1	Scratch = Ø	QTY		
	X		Ø<0.1	Except	Accept	
		—	$0.1 \le \emptyset \le 0.15$	2	Accept	
1.5	$\emptyset = \frac{x+y}{2}$	<	$0.15 < \emptyset \le 0.25$	1	Accept	
	2 7/10	<u> </u>	Ø>0.25	1	Reject	MIN
	LCD scratch	Scratch =L	scratch =W	QTY		
			W≤0.015		Accept	
		< 0.5	W≤0.02	2	Accept	
1.6		<1.0	W≤0.03	1	Accept	
	Scratch depth see sample	≥1.0	W≧0.03	1	Reject	MIN
			QTY			
	White or black spot on LCD	-	Ø<0.1		Accept	
1.7	x + y		0.1 \le \O < 0.2	2	Accept	
1.7	$\emptyset = \frac{x+y}{2}$) >	0.2≦Ø≦0.25	1	Accept	
			Ø>0.25	1	Reject	MIN
			Bevy point	-	Reject	MIN

Item		Standard descripti	ion of inspectio	n		Standard	Defect type
	Black line in J CD		(L)	(W)	QTY		
1.8			L≦1.0	$W \le 0.025$	2	Accept	
			1.0<1≤1.5	$W \le 0.025$	1	Accept	
		1.5 <l< td=""><td>W>0.025</td><td>1</td><td>Reject</td><td>MIN</td></l<>	W>0.025	1	Reject	MIN	
				Size	QTY		
1.9	Round air bubble			Ø<0.15	2	Accept	
1.9	Round an bubble	$0.15 \le \emptyset \le 0.$	25 1	Accept			
				Ø>0.25	0	Reject	MIN
		(L)	(W)	QTY			
1.10	Line defect	L<0.5	W<0.02	2	Accept		
1.10	Eine defect		L<1.0	W<0.03	1	Accept	
			L≥1.0	$W \ge 0.3$	0	Reject	MIN
	Finger print					Reject	MIN
2	PCB/COB specification						
	PCB deformity			L	Н		
		≤6.0mm	≤1.5mm	Accept			
2.1				>6.0mm	≤1.5mm	Reject	MIN
				<6.0mm	>1.5mm	Reject	MIN
		Ĺ		>6.0mm	>1.5mm	Reject	MIN
2.2	Deformity at PCB edge, dam	age circuit.				Reject	MAJ
			//	L	Н		
	Convex at PCB edge	\leftarrow		≤6.0mm	≤1.5mm	Accept	
2.3		_		>6.0mm	≤1.5mm	Reject	MIN
				<6.0mm	>1.5mm	Reject	MIN
					>1.5mm	Reject	MIN
2.4	Damage excess 2x2mm at the	Reject	MIN				
	Scratch on PCB surface					See sample	MIN
	Scratch on PCB coat/leakage	Reject	MAJ				
	Open circuit					Reject	MAJ
2.8	PCB PTH open					Reject Accept	MAJ
2.9	Repair PCB PTH QTY≤2PCS						
	-			Q	TY≥3PCS	Reject	MAJ
2.10	Color different from one side	to another side.				Reject	MIN
2.11	Repaired solder mask area		≦30mm ²	Accept			
2.11	-	≧ 30mm ²	Reject	MIN			
	Scratch circuit, damage Circuit	damage $a \leq 1/2w \text{ or } b \leq w$				Accept	
2.12		a>1/2w or b>w					
3	Bezel specification			<u> </u>		1	<u> </u>
3.1	Wrong Materials		MAJ				
3.2	Incorrect dimension						MAJ
3.3	Bezel broken						MAJ
3.4	Rust on Bezel						MAJ
		Si	ze	cm ² /per			
	Hole or dirty on oil			≤ 0.3	2	Accept	
		Top surface		Ø≦0.5	1	Accept	
3.5		- F ~		>0.5	0	Reject	MIN
3.3	Paint surface			≤0.5	2	Accept	171111
		Side		0.8	1	Accept	
		Side		>0.8	0	Reject	MIN
			Į Ø	~ V.O	U	Reject	171117

Item	Standard descrip	tion of in	spection			Standard	Defect type
3.6	Bezel bow or twist			h≤0.01 mm/mm		Accept	
3.0	bezer bow of twist			h>0.01 n	nm/mm	Reject	MIN
3.7	d1 d2			d1-d2 ≤ tolerance		Accept	
					d1-d2>tolerance		MIN
	Scratch on bezel		F	ace Accept QTY			
	~ 1	_	L	W W≤0.15	Not defined		
			L≦3	W≤0.20	2	See Sample	
		_	L≦2	W≦0.3	2		
3.8				W>0.3			
	- 			ide	Accept QTY		
		-	L	W		-	
		_	- L≦3	$W \le 0.2$ $W \le 0.25$	except 2	See Sample	
						Sample	
			L≦2	W≤0.3	2		
3.9	Twist angle $\alpha = 45^{\circ} + 5^{\circ}$	<u>λ</u> α	\	\		Accept	
3.10	Void gap between bezel and PCB					Reject	MIN
3.11	Bezel clip incorrectly NG						MIN
4	Solder specification					Reject	
4.1	Wrong component						MAJ
4.2	Broken component Component legs extend beyond the Legs >pad distance(w) on solder a					Reject Accept	MAJ
4.3	Component legs extend Legs >pad distance(w)			d beyond the pad and) on solder area <w<sup>2</w<sup>		Reject	MIN
	Component Se 1/	nnce L <solder< td=""><td>legs</td><td>Accept</td><td></td></solder<>	legs	Accept			
	Solder legs offset L>1/4W					Reject	MIN
4.4	Component assembly defect					Reject	MIN
4.5	CHIP components hoist ≤ 0.5mm						
4.6	CHIP components hoist>0.5mm					Reject	MIN

Item	Standard description of inspection		Standard	Defect type
4.7	h≤2.0m		Accept	
	Components hoist	h>2.0mm	Reject	MIN
4.8	Switch (socket) hoist	$h \leq 0.5 mm$	Accept	
4.0	Switch (socket) hoist	h>0.5mm	Reject	MIN
4.9	Components cold solder or incomplete solder		Reject	MAJ
4.10	Solder PAD tilt up, but height (h) less than Solder PAD thickness (a)	Q	Accept	
4.11	Excess solder above components		Reject	Min
4.12	Insufficient solder below components height or less than diameter		Reject	MIN
4.13	Solder area less than soldering PAD Area by 2/3		Reject	MIN
4.14	Trimmed pin length beyond 0.09inch (2.3mm)		Reject	Min
5	Packing specification			
5.1	Wrong carton mark.		Reject	MAJ
5.2	Carton mark problem		Reject	MIN
5.3	Carton damage extend than 150mm		Reject	MAJ
5.4	Carton damage, scratch more 50mm, less 150mm.		Reject	MIN

Version: 2.1

11.PRECAUTIONS FOR USING LCD MODULES

11.1. HANDLING PRECAUTIONS

- 1. This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.
- 2. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
- 3. If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 4. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 5. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 6. If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol
- 7. Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
- 8. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 9. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 10. Do not attempt to disassemble or process the LCD module.
- 11. NC terminal should be open. Do not connect anything.
- 12. If the logic circuit power is off, do not apply the input signals.
- 13. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

11.2. POWER SUPPLY PRECAUTIONS:

- 1. Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
- 2. Prevent the application of reverse polarity to VDD and VSS, however briefly.
- 3. Use a clean power source free from transients. Power-up conditions are occasionally "jolting" and may exceed the maximum ratings of the modules.
- 4. The VDD power of the module should also supply the power to all devices that may access the display. Don't allow the data bus to be driven when the logic supply to the module is turned off.

11.3. OPERATING PRECAUTIONS:

- 1. DO NOT plug or unplug the module when the system is powered up.
- 2. Minimize the cable length between the module and host MPU.
- 3. For models with EL backlights, do not disable the backlight by interrupting the HV line. Unload inverters produce voltage extremes that may arc within a cable or at the display.
- 4. Operate the module within the limits of the modules temperature specifications.

11.4. MECHANICAL/ENVIRONMENTAL PRECAUTIONS:

- 1. Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the elastomeric connection and cause display failure.
- 2. Mount the module so that it is free from torque and mechanical stress.
- 3. Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
- 4. Always employ anti-static procedure while handling the module.
- 5. Prevent moisture build-up upon the module and observe the environmental constraints for storage temperature and humidity.
- 6. Do not store in direct sunlight
- 7. If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap

11.5. Storage Precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

11.6. Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- Terminal electrode sections.

12.USING LCD MODULES

12.1. Liquid Crystal Display Modules

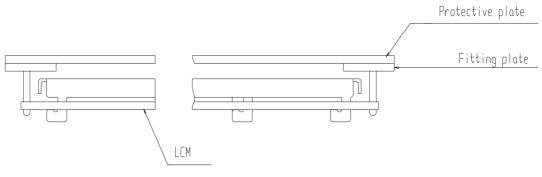
LCD is composed of glass and polarizer. Pay attention to the following items when handling.

- 1. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
- 2. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
- 3. N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
- 4. When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
- 5. Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- 6. Avoid contacting oil and fats.
- 7. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- 8. Do not put or attach anything on the display area to avoid leaving marks on.
- 9. Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
- 10. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

12.2. Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

1. Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



2. When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

12.3. Precaution for Handing LCD Modules

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the

module or making any alterations or modifications to it.

- 1. Do not alter, modify or change the shape of the tab on the metal frame.
- 2. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- 3. Do not damage or modify the pattern writing on the printed circuit board.
- 4. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- 5. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 6. Do not drop, bend or twist LCM.

12.4. Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- 1. Make certain that you are grounded when handing LCM.
- 2. Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- 3. When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- 4. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- 5. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- 6. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

12.5. Precaution for soldering to the LCM

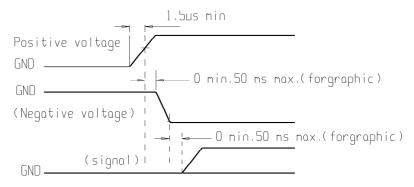
- Observe the following when soldering lead wire, connector cable and etc. to the LCM.
 - Soldering iron temperature: $310^{\circ}\text{C} \pm 10^{\circ}\text{C}$.
 - Soldering time: 3-4 sec.
 - Solder: eutectic solder.

If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

- 2. When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 3. When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

12.6. Precautions for Operation

- 1. Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- 2. Driving the LCD in the voltage above the limit shortens its life.
- 3. Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- 4. If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 5. Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40° C, 50% RH.
- 6. When turning the power on, input each signal after the positive/negative voltage becomes stable.



12.7. Storage

When storing LCDs as spares for some years, the following precaution are necessary.

- 1. Store them in a sealed polyethylene bag. If properly sealed, there is no need for desiccant.
- 2. Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- 3. The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
- 4. Environmental conditions:
 - Do not leave them for more than 168hrs. at 60°C.
 - Should not be left for more than 48hrs, at -20°C.

12.8. Safety

- 1. It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 2. If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

12.9. Limited Warranty

Unless agreed between DISPLAYTECH and customer, DISPLAYTECH will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with DISPLAYTECH LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to DISPLAYTECH within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DISPLAYTECH limited to repair and/or replacement on the terms set forth above. DISPLAYTECH will not be responsible for any subsequent or consequential events.

12.10. Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

- Broken LCD glass.
- PCB eyelet's damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.